#### TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62591AP,TD62592AP,TD62593AP,TD62594AP TD62595AP,TD62595AF,TD62596AP,TD62596AF TD62597AP,TD62597AF,TD62598AP,TD62598AF

#### 8CH SINGLE DRIVER

The TD62591AP Series are comprised of eight NPN Transistor Arrays.

Applications include relay, hammer, lamp and display (LED) drivers.

## **FEATURES**

- Output current (single output) 200 mA (Max)
- High sustaining voltage output 50V (Min)
- Low saturation voltage  $V_{CE (sat)} = 0.8 \text{ V}$
- @Iout = 150mA·inputs compatible with various type logic.

TD62591, TD62595AP, TD62595AF: external.

general purpose

TD62592, TD62596AP, TD62596AF : 10.5 k $\Omega$  + 7V

zener diode 14~25 V

**PMOS** 

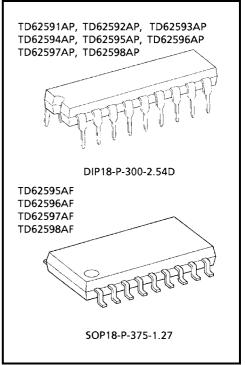
TD62593, TD62597AP, TD62597AF : 2.7 kΩ

TTL. 5 V CMOS

TD62594, TD62598AP, TD62598AF : 10.5 kΩ

6~15 V PMOS, CMOS

Package type-AP : DIP-18pinPackage type-AF : SOP-18pin



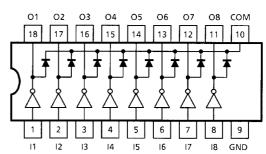
Weight

DIP18-P-300-2.54D : 1.47 g (Typ.) SOP18-P-375-1.27 : 0.5 g (Typ.)

#### PIN CONNECTION (TOP VIEW)

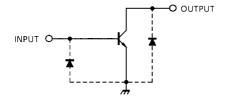
TD62591AP, TD62592AP, TD62593AP, TD62594AP

NC 01 02 03 04 05 06 07 08 11 10 18 17 16 15 14 13 12 2 3 4 5 6 7 8 9 12 13 15 16 17 18 GND TD62595AP, TD62595AF, TD62596AP, TD62596AF TD62597AP, TD62597AF, TD62598AP, TD62598AF

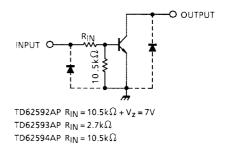


# **SCHEMATICS (EACH DRIVER)**

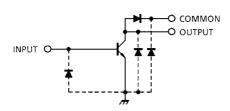
#### TD62591AP



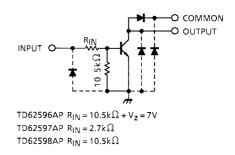
#### TD62592AP, TD62593AP, TD62594AP



TD62595AP, TD62595AF



TD62596AP, TD62596AF, TD62597AP, TD62597AF, TD62598AF, TD62598AF



Note: The input and output parasitic diodes cannot be used as clamp diodes.

# MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V <sub>CEO</sub>	50	V
Collector-Base Voltage	$V_{CBO}$	50	V
Clamp Diode Reverse Voltage	V <sub>R</sub> (Note 1)	50	V
Collector Current	IC	200	mA / ch
Input Voltage	V <sub>IN</sub> (Note 2)	-0.5~30	V
Input Current	I <sub>IN</sub> (Note 3)	25	mA
Power Dissipation	P <sub>D</sub> (Note 4)	0.96 (Note 5) / 1.47	W
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Storage Temperature	T <sub>stg</sub>	-55~150	°C

Note 1: Except TD62591~TD62594AP

Note 2: Except TD62591AP, TD62595AP, TD62595AF

Note 3: Only TD62591AP, TD62595AP, TD62595AF

Note 4: Delated above 25°C in the proportion of 11.7mW / °C (AP-Type), 7.7mW / °C (F, AF-Type)

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Note 5: SOP-18pin



# RECOMMENDED OPERATING CONDITIONS (Ta = $-40 \sim 85$ °C)

CHARAC	TERISTIC	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Collector-Emitter V	/oltage	$V_{CEO}$	_	0	_	50	V
Collector-Base Vo	Itage	V <sub>CBO</sub>	_	0	_	50	V
Collector Current		IC	-	0	_	150	mA / ch
Clamp Diode Reve	rse Voltage	V <sub>R</sub>	(Note1)	7	_	50	V
Input Voltage		V <sub>IN</sub>	(Note2)	0	_	25	V
Input Current		I <sub>IN</sub>	(Note3)	0	_	10	mA
Input Voltage (Output On)	TD62592 TD62596	Vin (on)	_	14.0	_	25	
	TD62593 TD62597			2.4	_	25	V
	TD62594 TD62598			7.0	_	25	
Power Dissipation	AP	- P <sub>D</sub>	_	_	_	0.52	W
	AF		_	ı	_	0.355	VV

# **ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)**

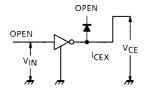
CHARA	CTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION		MIN	TYP.	MAX	UNIT
Output Leakage (	Current	I <sub>CEX</sub>	1	V <sub>CE</sub> = 50 V, V <sub>IN</sub>	= 0	_	_	10	μΑ
Collector-Emitter Saturation Voltage		V <sub>CE (sat)</sub>	2	I <sub>C</sub> = 10 mA, I <sub>IN</sub> = 0.4 mA		_	_	0.2	V
				I <sub>C</sub> = 150 mA, I <sub>IN</sub> = 3.0 mA		_	_	0.8	
DC Current Transfer Ratio		h <sub>FE</sub>	2	V <sub>CE</sub> = 10 V I <sub>C</sub> = 10 mA	(Note 3)	70	_	_	_
					(Note 2)	50	_	_	
Input Current	TD62591 TD62595		3	I <sub>C</sub> = 50 mA		1	_	0.65	
	TD62592 TD62596			V <sub>IN</sub> = 14V, I <sub>C</sub> = 50 mA		_	_	0.9	^
	TD62593 TD62597	lin (ON)		V <sub>IN</sub> = 2.4 V, I <sub>C</sub> = 50 mA		_	_	0.9	mA
	TD62594 TD62598			V <sub>IN</sub> = 7.0 V, I <sub>C</sub> = 50 mA		_	_	0.9	
Turn-On Delay		t <sub>ON</sub>	4	Vour = 50 V P	- 330 O	_	0.1	_	μs
Turn-Off Delay		tOFF	1 4	$V_{OUT}$ = 50 V, $R_L$ = 330 $\Omega$		_	0.3	_	μs

Note 1: Except TD62591~TD62594AP

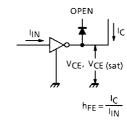
Note 2: Except TD62591AP, TD62595AP, TD62595AF Note 3: Only TD62591AP, TD62595AP, TD62595AF

## **TEST CIRCUIT**

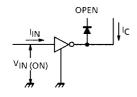
## 1. ICEX



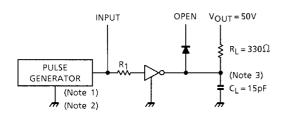
## 2. hfe, VCE (sat)

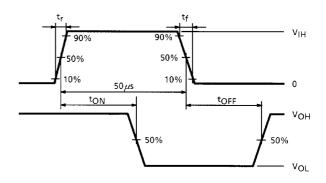


# 3. V<sub>IN</sub> (ON)



#### 4. ton, toff





Note 1: Pulse width 50  $\mu s$ , duty cycle 10%

Output impedance 50  $\Omega$ ,  $t_r \le 5$  ns,  $t_f \le 10$  ns

Note 2: See below

Input Condition

TYPE NUMBER	R <sub>IN</sub>	V <sub>IH</sub>	
TD62591AP, TD62595AP, TD62595AF	2.7 kΩ	3 V	
TD62592AP, TD62596AP, TD62596AF	0 Ω	15 V	
TD62593AP, TD62597AP, TD62597AF	0 Ω	3 V	
TD62594AP, TD62598AP, TD62598AF	0 Ω	10 V	

Note 3: CL includes probe and jig capacitance

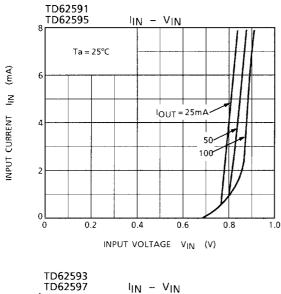
## PRECAUTIONS for USING

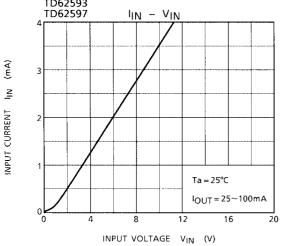
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

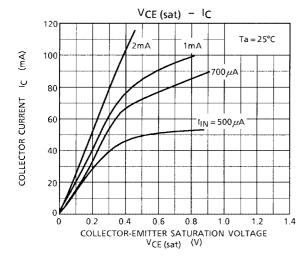
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

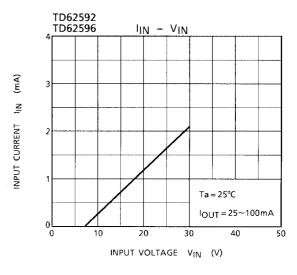
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

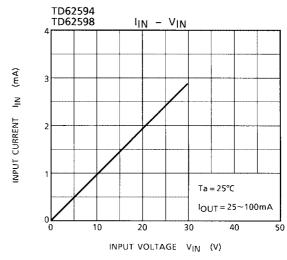
4

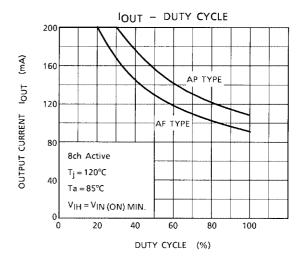


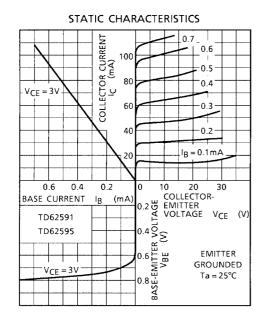


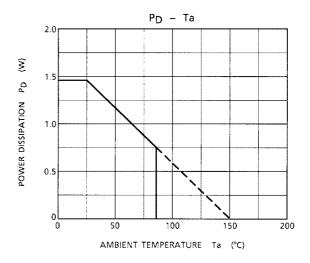


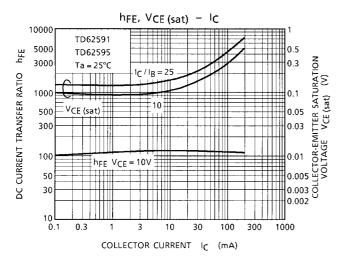












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# **PACKAGE DIMENSIONS**

DIP18-P-300-2.54D

Unit: mm

25.1MAX

24.6±0.2

1.4±0.1

0.5±0.1

0.5±0.1

0.5±0.1

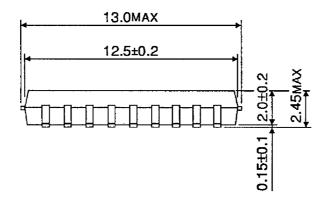
Weight: 1.47 g (Typ.)

Unit: mm

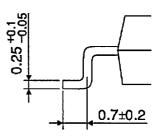
# **PACKAGE DIMENSIONS**

SOP18-P-375-1.27

1.17TYP 9 0.4±0.1 \$\int 0.25 \text{ }\text{ }\



1.27



Weight: 0.50 g (Typ.)

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000707EBA

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